

Irish Standard I.S. EN 60512-28-100:2013

Connectors for electronic equipment - Tests and measurements -- Part 28 -100: Signal integrity tests up to 1 000 MHz on IEC 60603-7 and IEC 61076-3 series connectors - Tests 28a to 28g (IEC 60512-28-100:2013 (EQV))

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| This document replaces | ÷ | This document EN 60512-28-10 | | Publish 5 April, | |
|---|---|---------------------------------|-----------------------------|---------------------|--------------------------|
| This document was publ under the authority of th 24 April, 2013 | | omes into effect on: | | | ICS number: 31.220.10 |
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EUROPEAN STANDARD

EN 60512-28-100

NORME EUROPÉENNE EUROPÄISCHE NORM

April 2013

ICS 31.220.10

English version

Connectors for electronic equipment Tests and measurements Part 28-100: Signal integrity tests up to 1 000 MHz on IEC 60603-7 and IEC 61076-3 series connectors - Tests 28a to 28g

(IEC 60512-28-100:2013)

Connecteurs pour équipements électroniques - Essais et mesures -Partie 28-100: Essais d'intégrité des signaux jusqu'à 1 000 MHz sur les connecteurs des séries CEI 60603-7 et CEI 61076-3 -Essais 28a à 28g (CEI 60512-28-100:2013) Steckverbinder für elektronische Einrichtungen -Mess- und Prüfverfahren -Teil 28-100: Signalintegritätsprüfungen bis 1 000 MHz an Steckverbindern der Reihen IEC 60603-7 und IEC 61076-3 -Prüfungen 28a bis 28g (IEC 60512-28-100:2013)

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EN 60512-28-100:2013

- 2 -

Foreword

The text of document 48B/2322/FDIS, future edition 1 of IEC 60512-28-100, prepared by SC 48B "Connectors" of IEC/TC 48 "Electromechanical components and mechanical structures for electronic equipment" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN 60512-28-100:2013.

The following dates are fixed:

| • | latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement | (dop) | 2013-12-13 |
|---|---|-------|------------|
| | Standard or by chaorsement | | |

 latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2016-03-13

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EN 60512-28-100:2013

Annex ZA

(normative)

Normative references to international publications with their corresponding European publications

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

| <u>Publication</u> | <u>Year</u> | <u>Title</u> | EN/HD | <u>Year</u> |
|--------------------|-------------|---|-----------------|-------------|
| IEC 60050-581 | - | International Electrotechnical Vocabulary (IEV) - Part 581: Electromechanical components for electronic equipment | - | - |
| IEC 60512-1 | - | Connectors for electronic equipment - Tests and measurements - Part 1: General | EN 60512-1 | - |
| IEC 60512-26-100 | 2008 | Connectors for electronic equipment - Tests and measurements - Part 26-100: Measurement setup, test and reference arrangements and measurements for connectors according to IEC 60603-7 - Tests 26a to 26g | EN 60512-26-100 | 2008 |
| IEC 60603-7 | Series | Connectors for electronic equipment | EN 60603-7 | Series |
| IEC 61076-1 | - | Connectors for electronic equipment - Product requirements - Part 1: Generic specification | EN 61076-1 | - |
| IEC 61076-3-104 | - | Connectors for electronic equipment - Product requirements - Part 3-104: Detail specification for 8-way, shielded free and fixed connectors for data transmissions with frequencies up to 1 000 MHz | EN 61076-3-104 | - |
| IEC 61076-3-110 | - | Connectors for electronic equipment - Product requirements - Part 3-110: Detail specification for shielded, free and fixed connectors for data transmission with frequencies up to 1 000 MHz | EN 61076-3-110 | - |
| IEC 61156 | Series | Multicore and symmetrical pair/quad cables for digital communications - Part 1-2: Electrical transmission characteristics and test methods of symmetrical pair/quad cables | - | - |
| IEC 61156-6 | - | Multicore and symmetrical pair/quad cables for digital communications - Part 6: Symmetrical pair/quad cables with transmission characteristics up to 1 000 MHz - Work area wiring - Sectional specification | | - |

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I.S. EN 60512-28-100:2013

EN 60512-28-100:2013

- 4 -

| <u>Publication</u> | <u>Year</u> | <u>Title</u> | EN/HD | <u>Year</u> |
|--------------------|-------------|--|-------------|-------------|
| IEC 61169-16 | - | Radio-frequency connectors - Part 16: RF coaxial connectors with inner diameter of outer conductor 7 mm (0,276 in) with screw coupling - Characteristic impedance 50 ohms (75 ohms) (Type N) | EN 61169-16 | - |
| IEC 62153-4-12 | - | Metallic communication cable test methods Part 4-12: Electromagnetic compatibility (EMC) - Coupling attenuation or screening attenuation of connecting hardware - Absorbing clamp method | | - |
| ISO/IEC 11801 | - | Information technology - Generic cabling for customer premises | - | - |

- 2 - 60512-28-100 © IEC:2013

CONTENTS

| FO | REWC |)RD | | 5 |
|----|------|-----------|--|----|
| 1 | Scop | e | | 7 |
| 2 | Norm | ative re | ferences | 7 |
| 3 | Term | s, defini | tions and acronyms | 8 |
| | 3.1 | | and definitions | |
| | 3.2 | | ms | |
| 4 | | - | arrangement | |
| | 4.1 | | strumentation | |
| | 4.2 | | rement precautions | |
| | 4.3 | | mode S-parameter nomenclature | |
| | 4.4 | | I cables and interconnect for network analysers | |
| | 4.5 | | ements for switching matrices | |
| | 4.6 | • | ture requirements | |
| | 4.7 | Require | ements for termination performance at calibration plane | 13 |
| | 4.8 | Refere | nce loads for calibration | 13 |
| | 4.9 | Calibra | tion | 14 |
| | 4.10 | Termin | ation loads for termination of conductor pairs | 14 |
| | | 4.10.1 | General | 14 |
| | | 4.10.2 | Verification of termination loads | 15 |
| | 4.11 | | ation of screens | |
| | 4.12 | | ecimen and reference planes | |
| | | | General | 15 |
| | | 4.12.2 | Interconnections between device under test (DUT) and the calibration plane | 16 |
| | 4.13 | Overall | test setup requirements | |
| 5 | | | easurement up to 1 000 MHz | |
| | 5.1 | | ıl | |
| | 5.2 | | on loss, Test 28a | |
| | ·- | 5.2.1 | Object | |
| | | 5.2.2 | Connecting hardware insertion loss | |
| | | 5.2.3 | Test method | |
| | | 5.2.4 | Test set-up | |
| | | 5.2.5 | Procedure | 19 |
| | | 5.2.6 | Test report | 20 |
| | | 5.2.7 | Accuracy | 20 |
| | 5.3 | Return | loss, Test 28b | 20 |
| | | 5.3.1 | Object | 20 |
| | | 5.3.2 | Connecting hardware return loss | 20 |
| | | 5.3.3 | Test method | |
| | | 5.3.4 | Test set-up | 21 |
| | | 5.3.5 | Procedure | |
| | | 5.3.6 | Test report | |
| | _ | 5.3.7 | Accuracy | |
| | 5.4 | | nd crosstalk (NEXT), Test 28c | |
| | | 5.4.1 | Object | |
| | | 5.4.2 | Connecting hardware NEXT | 21 |

| 60512 | -28-1 | വ ര | IEC: | 2013 |
|-------|-------|-----|------|------|

- 3 -

| | 5.4.3 | rest method | ∠ ۱ |
|------------|----------------|--|-----|
| | 5.4.4 | Test set-up | 22 |
| | 5.4.5 | Procedure | 22 |
| | 5.4.6 | Test report | 23 |
| | 5.4.7 | Accuracy | 23 |
| 5.5 | Far-er | nd crosstalk (FEXT), Test 28d | 23 |
| | 5.5.1 | Object | |
| | 5.5.2 | Connecting hardware FEXT | |
| | 5.5.3 | Test method | |
| | 5.5.4 | Test set-up | |
| | 5.5.5 | Procedure | |
| | 5.5.6 | Test report | |
| | 5.5.7 | Accuracy | |
| 5.6 | | fer impedance (Z _T), Test 28e | |
| 5.7 | | verse conversion loss (TCL), Test 28f | |
| | 5.7.1 | Object | |
| | 5.7.2 | Connecting hardware TCL | |
| | 5.7.3 | Test method | |
| | 5.7.4 | Test set-up | |
| | 5.7.5 | Procedure | |
| | 5.7.6 | Test report | |
| 5 0 | 5.7.7 | Accuracy | |
| 5.8 | | verse conversion transfer loss (TCTL), Test 28g | |
| | 5.8.1 | Object | |
| | 5.8.2 | Connecting hardware TCTL | |
| | 5.8.3 5.8.4 | Test method Test set-up | |
| | 5.8.5 | Procedure | |
| | 5.8.6 | Test report | |
| | 5.8.7 | Accuracy | |
| 5.9 | | ing attenuation | |
| | • | ative) Example derivation of mixed mode parameters using the modal | |
| | | echnique | |
| • | | ative) Test pins – Dimensions and references | |
| | | | |
| Bibliogi | арпу | | |
| - : | l Diam | and of a simple and odd A post device | 4.0 |
| _ | _ | ram of a single ended 4 port device | |
| _ | _ | am of a balanced 2 port device | |
| • | | ration of reference loads | |
| Figure 5 | 5 – Resis | stor termination networks | 15 |
| Figure 6 | 6 – Defin | ition of reference planes | 16 |
| Figure 7 | 7 – Inser | tion loss and TCTL measurement | 20 |
| Figure 8 | 3 – NEXT | 「measurement | 22 |
| • | | measurement | |
| • | | urn loss and TCL measurement | |
| _ | | tage and current on balanced DUT | |
| • | | tage and current on unbalanced DUTtage and current on unbalanced DUT | |
| igure / | ∠ – voi | tage and current on unbalanced DOT | 30 |

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I.S. EN 60512-28-100:2013

| 4 – | 60512-28-100 © IEC:2013 |
|-----|-------------------------|
| | |

| Figure B.1 – Example of pin and fixed connector dimensions | 32 |
|--|----|
| | |
| Table 1 – Mixed mode S-parameter nomenclature | 11 |
| Table 2 – Switch performance recommendations | 12 |
| Table 3 – Test fixture requirements | 13 |
| Table 4 – Requirements for terminations at calibration plane | 13 |
| Table 5 – Interconnection DM return loss requirements | 18 |
| Table 6 – Overall test setup requirements | 18 |

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- 5 -

INTERNATIONAL ELECTROTECHNICAL COMMISSION

CONNECTORS FOR ELECTRONIC EQUIPMENT – TESTS AND MEASUREMENTS –

Part 28-100: Signal integrity tests up to 1 000 MHz on IEC 60603-7 and IEC 61076-3 series connectors – Tests 28a to 28g

FOREWORD

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International Standard IEC 60512-28-100 has been prepared by subcommittee 48B: Connectors, of IEC technical committee 48: Electromechanical components and mechanical structures for electronic equipment.

The text of this standard is based on the following documents:

| FDIS | Report on voting |
|---------------|------------------|
| 48B/2322/FDIS | 48B/2332/RVD |

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

-6-

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A list of all parts of IEC 60512 series, under the general title *Connectors for electronic equipment – Tests and measurements*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

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-7-

CONNECTORS FOR ELECTRONIC EQUIPMENT – TESTS AND MEASUREMENTS –

Part 28-100: Signal integrity tests up to 1 000 MHz on IEC 60603-7 and IEC 61076-3 series connectors – Tests 28a to 28g

1 Scope

This part of IEC 60512 specifies the test methods for transmission performance for IEC 60603-7 and IEC 61076-3 series connectors up to 1 000 MHz. It is also suitable for testing lower frequency connectors, however the test methodology specified in the detailed specification for any given connector remains the reference conformance test for that connector.

The test methods provided here are:

- insertion loss, test 28a;
- return loss, test 28b;
- near-end crosstalk (NEXT) test 28c;
- far-end crosstalk (FEXT), test 28d;
- transverse conversion loss (TCL), test 28f;
- transverse conversion transfer loss (TCTL), test 28g.

For the transfer impedance (ZT) test, see IEC 60512-26-100, test 26e.

For the coupling attenuation, see IEC 62153-4-12.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60050-581, International Electrotechnical Vocabulary (IEV) – Part 581: Electromechanical components for electronic equipment

IEC 60512-1, Connectors for electronic equipment – Tests and measurements – Part 1: General

IEC 60512-26-100:2008, Connectors for electronic equipment – Tests and measurements – Part 26-100: Measurement setup, test and reference arrangement and measurements for connectors according to IEC 60603-7 – Tests 26a to 26g

IEC 60603-7 (all parts), Connectors for electronic equipment

IEC 61076-1, Connectors for electronic equipment – Product requirements – Part 1: Generic specification



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